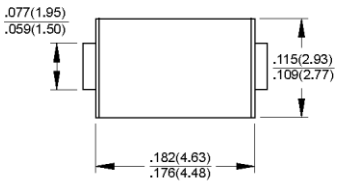
SR1A-S thru SR1M-S

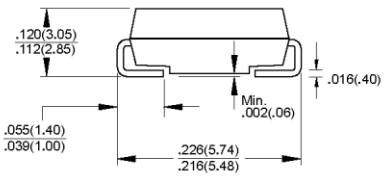
1.0 Amp. Fast Recovery Surface Mount Rectifiers
Voltage Range 50 to 1000 Volts Forward Current 1.0 Ampere

Features

- For surface mounted application
- Low profile package
- Easy pick and place
- Built-in strain relief, ideal for automated placement
- Plastic material used carries Underwriters Laboratory Classification 94V-O
- Fast switching for high efficiency
- High temperature soldering: 260°C/10 seconds at terminals

DO-214AC (SMAJ)





Dimensions in inches and (millimeters)

Mechanical Data

- Cases: New SMA molded plastic
- Terminals: Solder plated solderable per MIL-STD-750, Method 2026
- Polarity: Indicated by cathode band
- Weight: 0.004 ounce, 0.113 gram

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.
Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%

Parameter	Symbols	SR1A-S	SR1B-S	SR1D-S	SR1G-S	SR1J-S	SR1K-S	SR1M-S	Units
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified current See Fig. 1 @ T_L=90°C	$I_{(AV)}$	1.0							Amp
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	30.0							Amps
Maximum instantaneous forward voltage @ 1.0A	V_F	1.30							Volts
Maximum DC reverse current @T_A=25°C at rated DC blocking voltage @T_A=100°C	I_R	5.0 100							uA
Maximum reverse recovery time (Note 1)	t_{rr}	150				250	500		nS
Typical junction capacitance (Note 2)	C_J	10							pF
Typical thermal resistance (Note 3)	$R_{\theta JL}$	32.0							°C/W
Operating temperature range	T_J	-55 to +125							°C
Storage temperature range	T_{STG}	-55 to +150							°C

Notes: 1. Reverse Recovery Test Conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A
2. Measured at 1 MHz and Applied V_R=4.0 Volts
3. Thermal Resistance from Junction to Lead Mounted on P.C.B. with 0.2" x 0.2" (5.0 x 5.0 mm) Copper Pad Areas

RATINGS AND CHARACTERISTIC CURVES

FIG.1- MAXIMUM FORWARD CURRENT DERATING CURVE

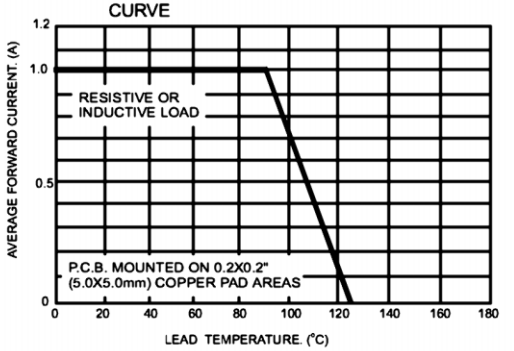


FIG.2- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

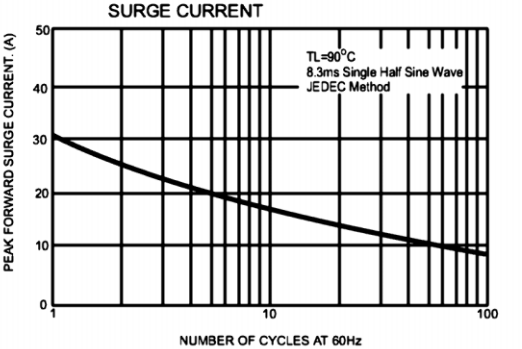


FIG.3- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS PER LEG

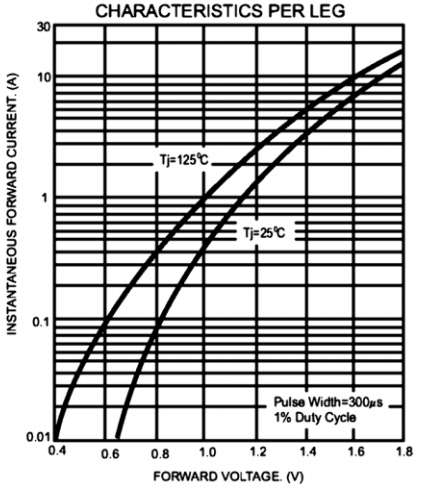


FIG.4- TYPICAL REVERSE CHARACTERISTICS

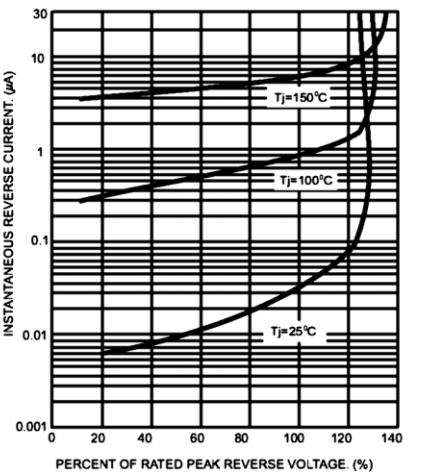


FIG.5- TYPICAL JUNCTION CAPACITANCE

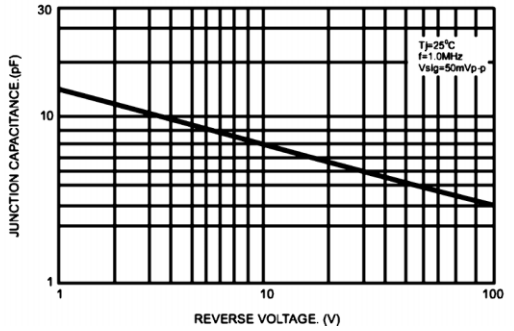
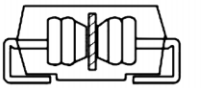


Figure :
New SMA Assembly



Round Lead
Process